

# **Maximum Ratings** ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V <sub>DSS</sub>	40	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 5)	$T_A = +25^{\circ}C$ $T_A = +100^{\circ}C$	I <sub>D</sub>	14.4 10.2	А
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$	I <sub>D</sub>	64.8 45.8	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	110	Α
Maximum Continuous Body Diode Forward Current (Note 6)		Is	55.5	A
Avalanche Current, L = 0.1mH		I <sub>AS</sub>	22.7	А
Avalanche Energy, L = 0.1mH		Eas	25.7	mJ

### **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	$P_{D}$	2.99	W
Thermal Resistance, Junction to Ambient (Note 5)		R <sub>0JA</sub>	50.4	°C/W
Total Power Dissipation (Note 6)	$T_C = +25^{\circ}C$	P <sub>D</sub>	55.5	W
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	2.7	°C/W
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +175	°C

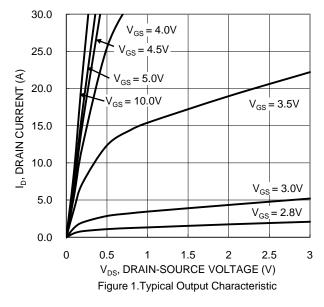
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 32V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	1.6	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	7.3	8.8	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	10	13		$V_{GS} = 5V, I_{D} = 10A$	
Diode Forward Voltage	$V_{SD}$	_	0.8	1.0	V	$V_{GS} = 0V, I_{S} = 10A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>iss</sub>	_	1,088	_		V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss		322	_	pF		
Reverse Transfer Capacitance	Crss	_	27	_			
Gate Resistance	Rg	_	2.6	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	7.4	_		V <sub>DS</sub> = 20V, I <sub>D</sub> = 10A	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	15.3	_	nC		
Gate-Source Charge	Q <sub>qs</sub>	_	2.4	_	IIC IIC		
Gate-Drain Charge	$Q_{gd}$	_	3.4	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.3	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 10A, R_{G} = 6\Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	7.5	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	16.7	_			
Turn-Off Fall Time	t <sub>F</sub>	_	5.8	_	1		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	20.2	_	ns L 40.4 II/II 400.4/		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	8.9	_	nC	I <sub>F</sub> = 10A, di/dt = 100A/μs	

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
- S. Device invalided of a standard of sociality 25 separation of the exposed drain pad).
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to product testing.







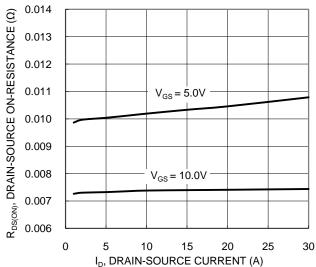


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

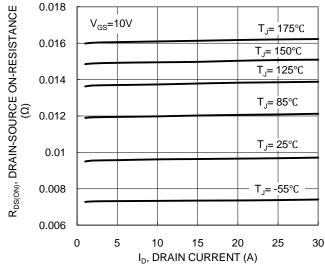
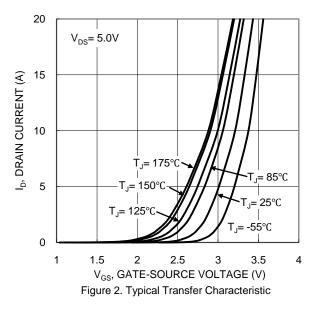
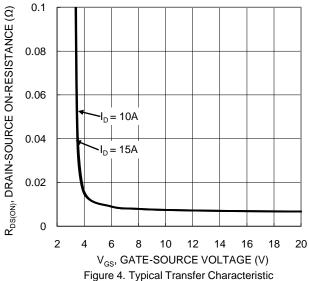


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





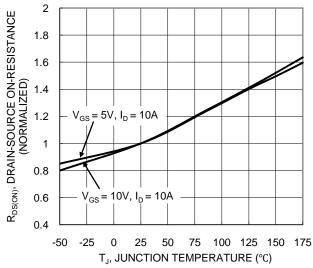


Figure 6. On-Resistance Variation with Temperature





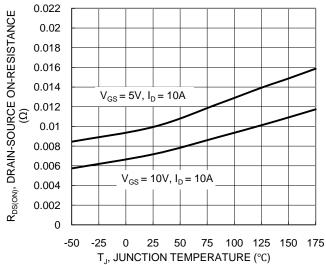


Figure 7. On-Resistance Variation with Temperature

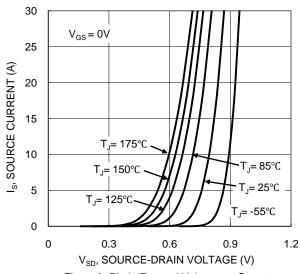


Figure 9. Diode Forward Voltage vs. Current

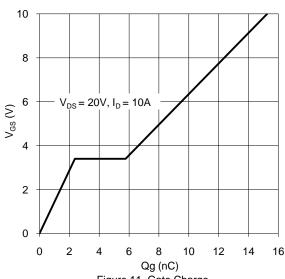
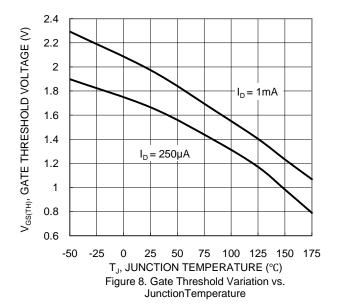
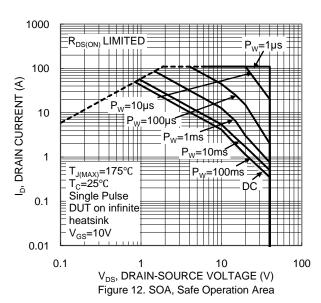


Figure 11. Gate Charge



10000 f=1MHz C<sub>T</sub>, JUNCTION CAPACITANCE (pF)  $\mathsf{C}_{\mathsf{iss}}$ 1000 Coss 100  $C_{rss}$ 10 1 0 10 15 20 25 30 35 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 10. Typical Junction Capacitance





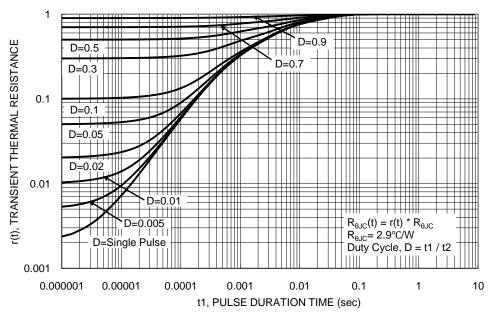


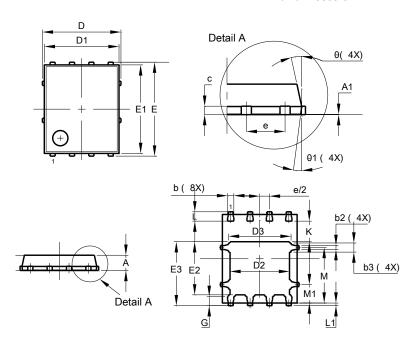
Figure 13. Transient Thermal Resistance



### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI5060-8

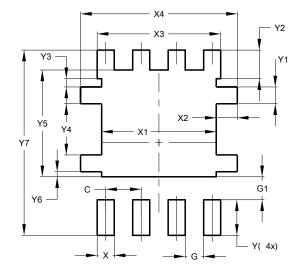


_					
PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	5.15 BSC				
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	6.15 BSC				
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI5060-8



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
X	0.610			
X1	4.100			
X2	0.755			
Х3	4.420			
X4	5.610			
Y	1.270			
Y1	0.600			
Y2	1.020			
Y3	0.295			
Y4	1.825			
Y5	3.810			
Y6	0.180			
Y7	6.610			



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